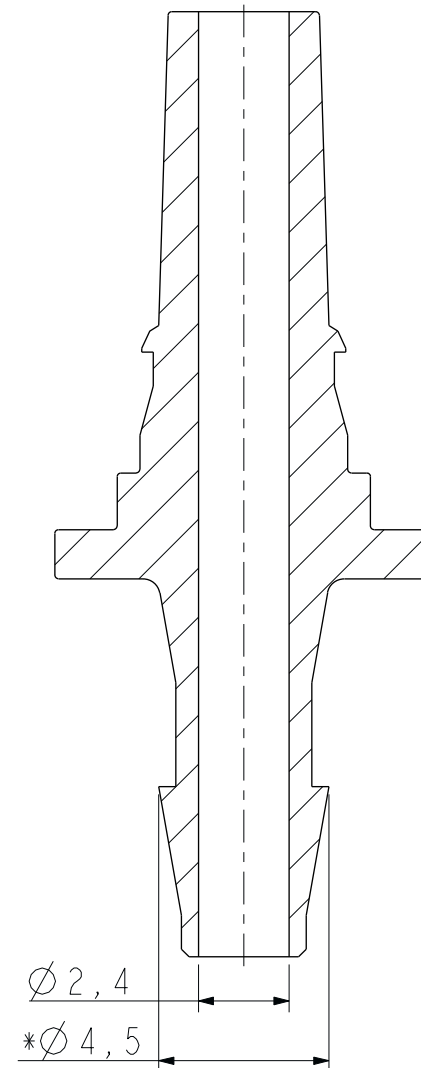
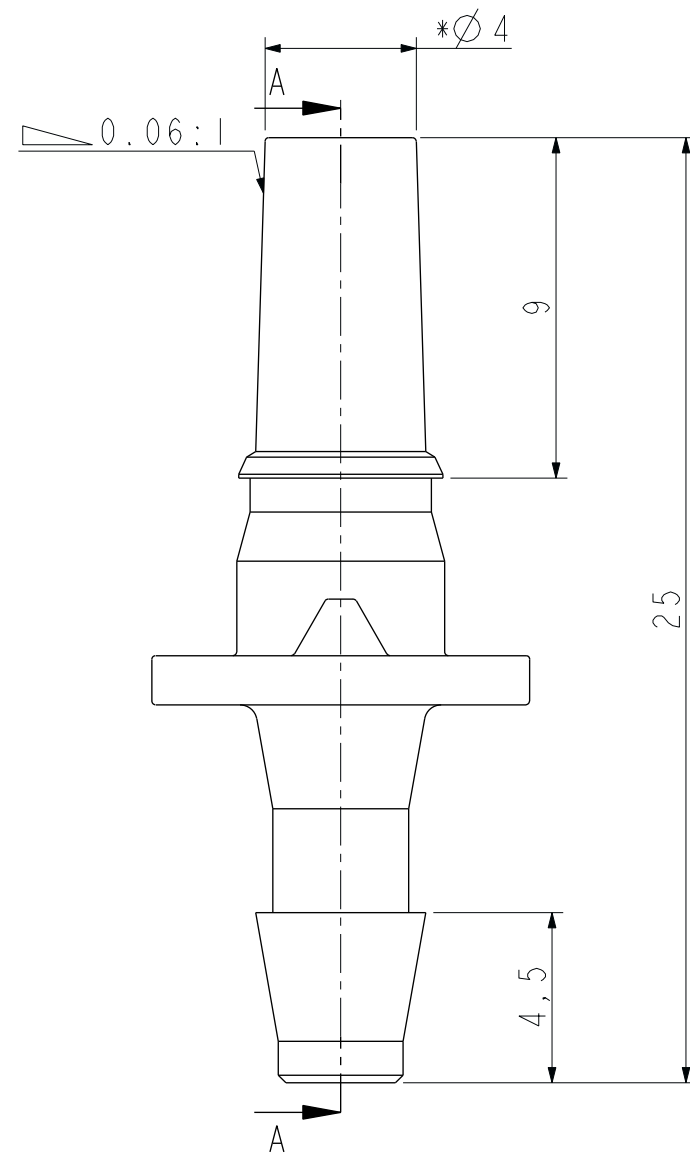
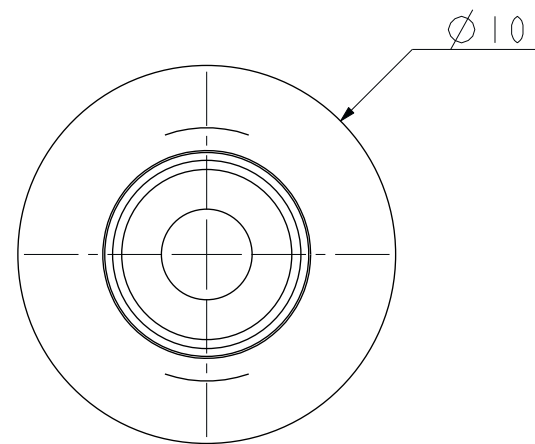


|     |     |             |        |      |
|-----|-----|-------------|--------|------|
| REV | ECN | DESCRIPTION | DESIGN | DATE |
| 001 | /   |             |        |      |
|     |     |             |        |      |



截面 A - A  
比例 5,000



技术要求：

1. 未注尺寸按3D
2. 未注线性及角度公差按ISO 2768-1-1989-c  
未注形状和位置公差按ISO 2768-2-1989-L
3. 所用材料符合RoHS 2.0要求
4. \*要素为关键要素；

|                                                                                       |  |                                                                                       |         |                             |           |       |
|---------------------------------------------------------------------------------------|--|---------------------------------------------------------------------------------------|---------|-----------------------------|-----------|-------|
|  |  |  | NAME    | 公鲁尔芯片 固定 LSL-32-PP-N 809562 |           |       |
| DESIGN                                                                                |  |                                                                                       | DWG No. | 443-02-00146                | REV       | 001   |
| CHECK                                                                                 |  |                                                                                       | MAT     | PP                          | Scale     | 5,000 |
| APPR.                                                                                 |  |                                                                                       | SF02    | IP / 0.272                  | <b>A3</b> | 1 / 1 |

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